



PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Attn: OIPE

Chikao IKENAGA et al.

Application No.: 10/781,947

Docket No.: 123784

Filed: February 20, 2004

For: SEMICONDUCTOR DEVICE FABRICATING APPARATUS AND
SEMICONDUCTOR DEVICE FABRICATING METHOD

REQUEST FOR CORRECTION OF PALM RECORDS

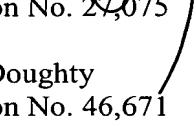
Commissioner for Patents
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Sir:

Attached is a photocopy of the original filing receipt on which errors have been corrected in red. These errors are being brought to the attention of the Patent and Trademark Office so that it may correct its records. A Supplemental Application Data Sheet is attached.

Respectfully submitted,


James A. Oliff
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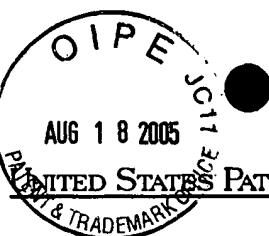

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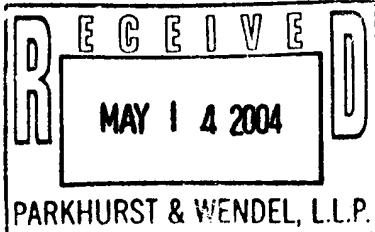
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APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY.DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/781,947	02/20/2004	2811	900	DAIN:763	7	12	2

6160
PARKHURST & WENDEL, L.L.P.
1421 PRINCE STREET
SUITE 210
ALEXANDRIA, VA 22314-2805



CONFIRMATION NO. 9701

UPDATED FILING RECEIPT



OC000000012651637

Date Mailed: 05/13/2004

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Assignment For Published Patent Application

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Domestic Priority data as claimed by applicant

Foreign Applications

JAPAN 2003-43680 02/21/2003

If Required, Foreign Filing License Granted: 05/13/2004

Projected Publication Date: 08/26/2004

Non-Publication Request: No

Early Publication Request: No

Title

Semiconductor device fabricating apparatus and semiconductor device fabricating method

Preliminary Class

257

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